Zener Diode

DZ36082D0L

Panasonic

DZ36082D0L

Silicon epitaxial planar type

For surge absorption circuit

■ Features

- · Excellent rising characteristics of zener current Iz
- · Low zener operating resistance Rz
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 03

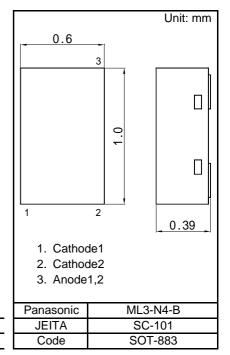
■ Packaging

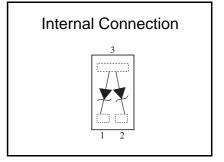
Embossed type (Thermo-compression sealing): 10 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Total power dissipation *1	PT	200	mW
Electrostatic discharge *2	ESD	±10	kV
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	ç

Note) *1: PT = 200 mW achieved with a printed circuit board. (2 Diode total)





■ Electrical Characteristics Ta = 25 °C ± 3 °C

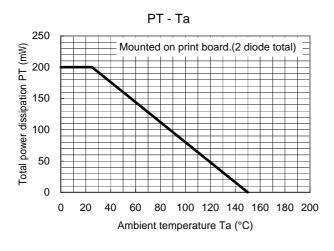
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage *1, *2	VZ	IZ = 5 mA	7.79		8.61	V
Zener operating resistance	RZ	IZ = 5 mA			30	Ω
Zener rise operating resistance	RZK	IZ = 0.5 mA			60	Ω
Reverse current	IR	VR = 5 V			0.1	μA
Temperature coefficient of zener voltage *3	SZ	IZ = 5 mA		4.8		mV/°C

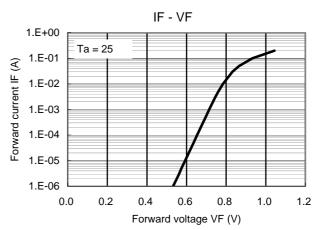
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - *1: The temperature must be controlled 25°C for VZ mesurement.
 VZ value measured at other temperature must be adjusted to VZ (25°C)
 - *2: VZ guaranted 20 ms after current flow.
 - *3: Tj = 25°C to 150°C

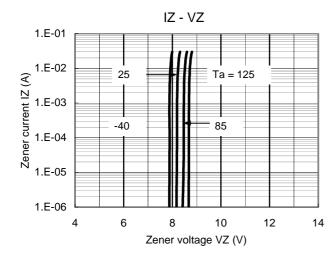
^{*2:} Test method:IEC61000_4_2(C = 150 pF,R = 330 Ω , Contact discharge:10 times)

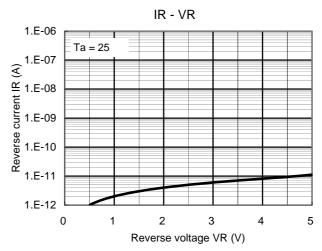
Zener Diode DZ36082D0L

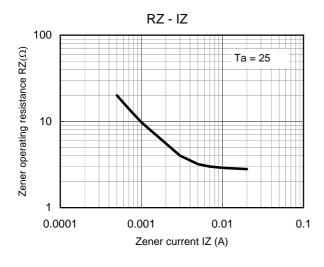
Technical Data (reference)

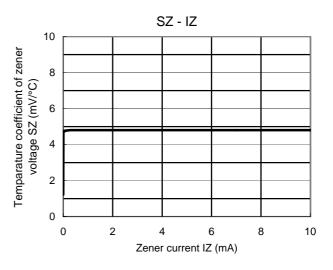












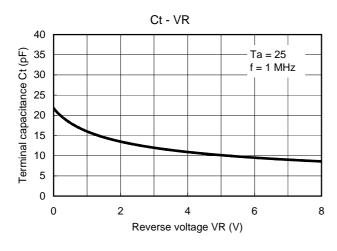
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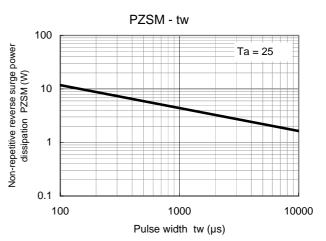
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Technical Data (reference)





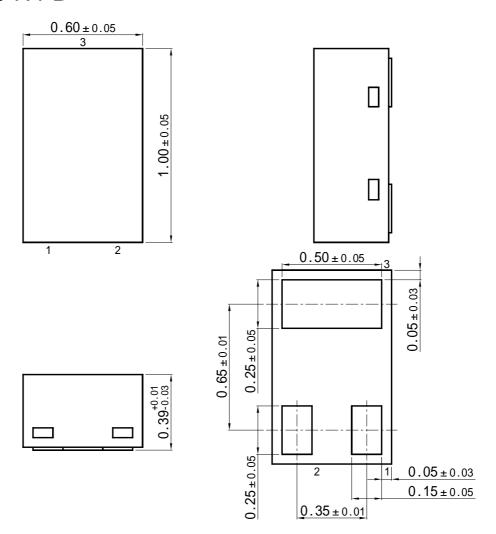
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Zener Diode

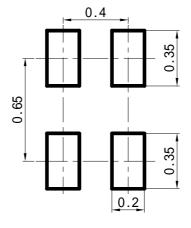
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ML3-N4-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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